

plastic quad flat package; 128 leads (lead length 1.6 mm); body 28 x 28 x 3.4 mm; high stand-off height

8 February 2016

Package information

1. Package summary

Terminal position code Q (quad)
Package type descriptive code QFP128
Package type industry code QFP128

Package style descriptive code QFP (quad flat package)

Package style suffix code NA (not applicable)

Package body material typeP (plastic)IEC package outline code134E13JEDEC package outline codeMS-022

Mounting method type S (surface mount)

Issue date 25-2-2003

Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	27.9	-	28	28.1	mm
E	package width	27.9	-	28	28.1	mm
Α	seated height	[tbd]	-	4.07	4.07	mm
A ₂	package height	3.15	-	3.4	3.7	mm
n ₂	actual quantity of termination	-	-	128	-	



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2. Package outline

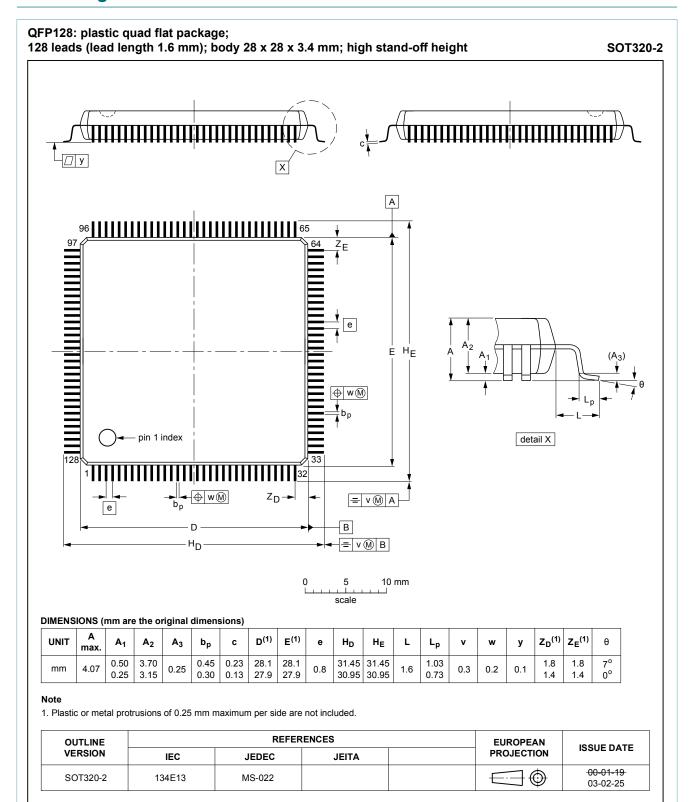
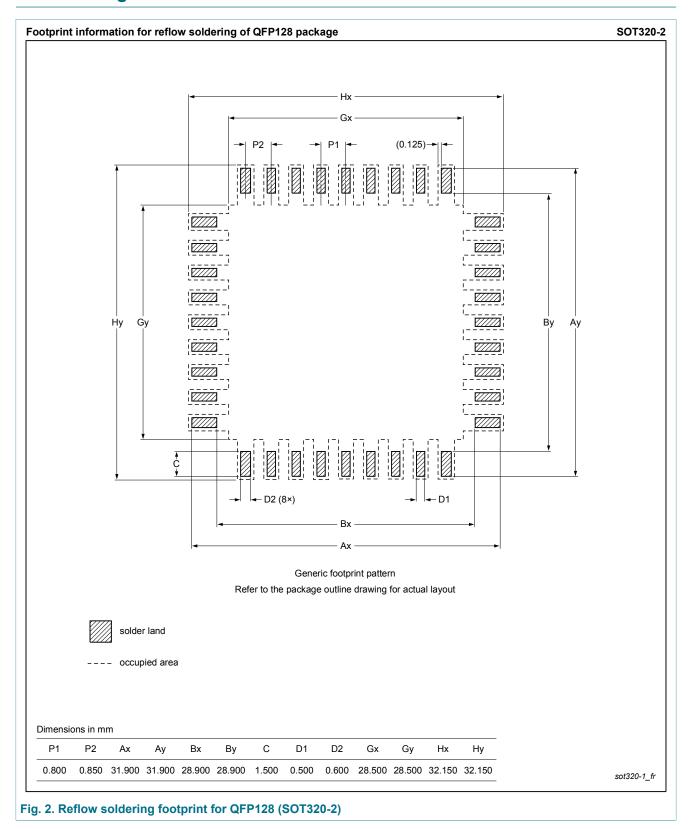


Fig. 1. Package outline QFP128 (SOT320-2)

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3. Soldering



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4. Legal information

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